### 3.2x1.6mm SMD CHIP LED LAMP

Part Number: KPTL-3216SURCK Hyper Red

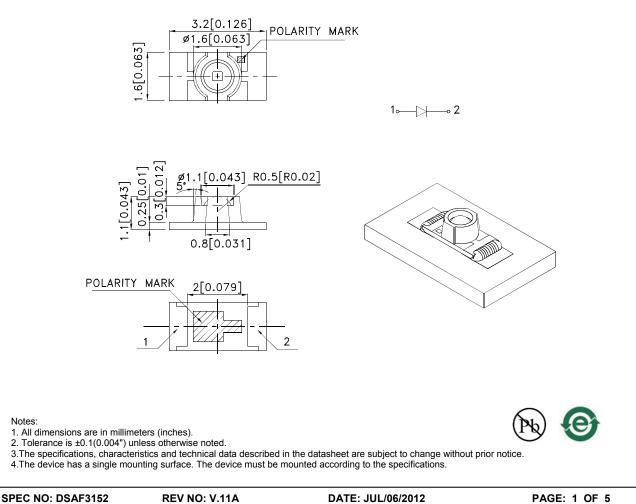
#### Features

- 3.2mmx1.6mm SMT LED, 1.1mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode.

#### **Package Dimensions**



CHECKED: Allen Liu

DATE: JUL/06/2012 DRAWN: D.M.Su PAGE: 1 OF 5 ERP: 1203004401

Selection Guide								
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]			
			Min.	Тур.	201/2			
KPTL-3216SURCK	Hyper Red (AlGaInP)	Water Clear	400	550	70°			
		Water Clear	*120	*230				

Notes: 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%. \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Max.	Units Test Condition		
λpeak	Peak Wavelength	Hyper Red	650	*645		nm	IF=20mA	
λD [1]	Dominant Wavelength	Hyper Red	630	*630		nm	IF=20mA	
Δλ1/2	Spectral Line Half-width	Hyper Red	28			nm	IF=20mA	
С	Capacitance	Hyper Red 35			pF	VF=0V;f=1MHz		
Vf [2]	Forward Voltage	Hyper Red	1.95		2.5	V	IF=20mA	
IR	Reverse Current	Hyper Red			10	uA	VR=5V	

Notes:

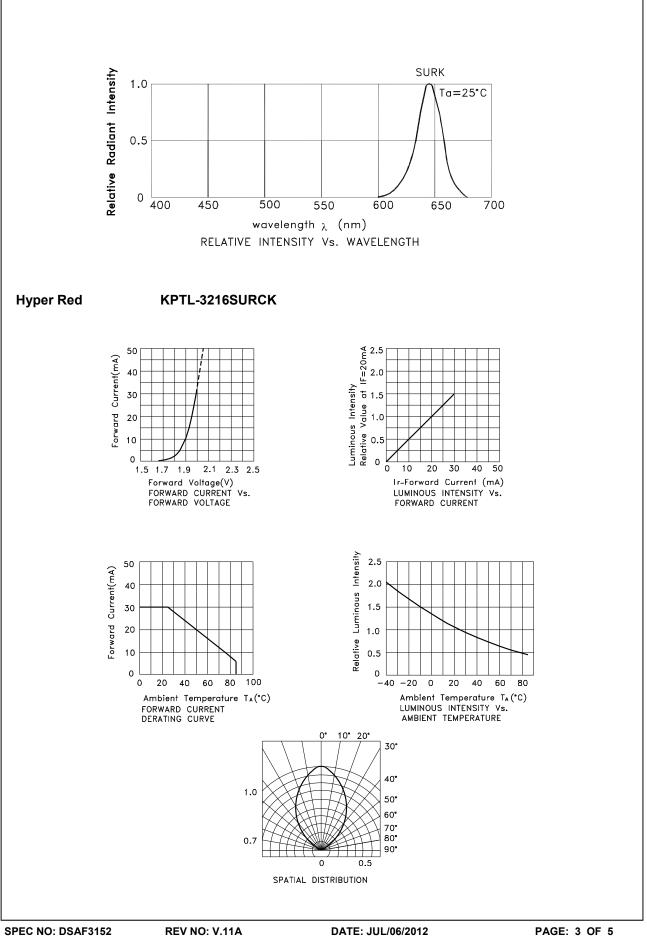
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. \* Wavelength value is traceable to the CIE127-2007 compliant national standards.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units			
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	185	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note:

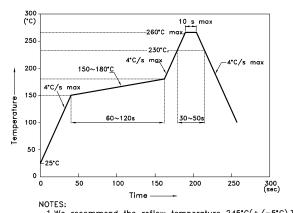
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



### **KPTL-3216SURCK**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



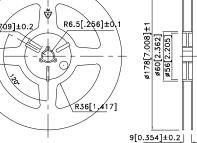
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.

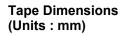


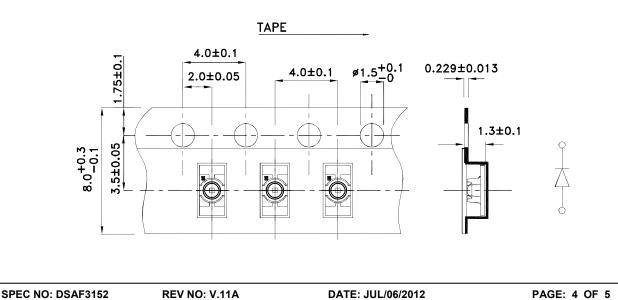
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**Reel Dimension** 







APPROVED: WYNEC

**CHECKED:** Allen Liu

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